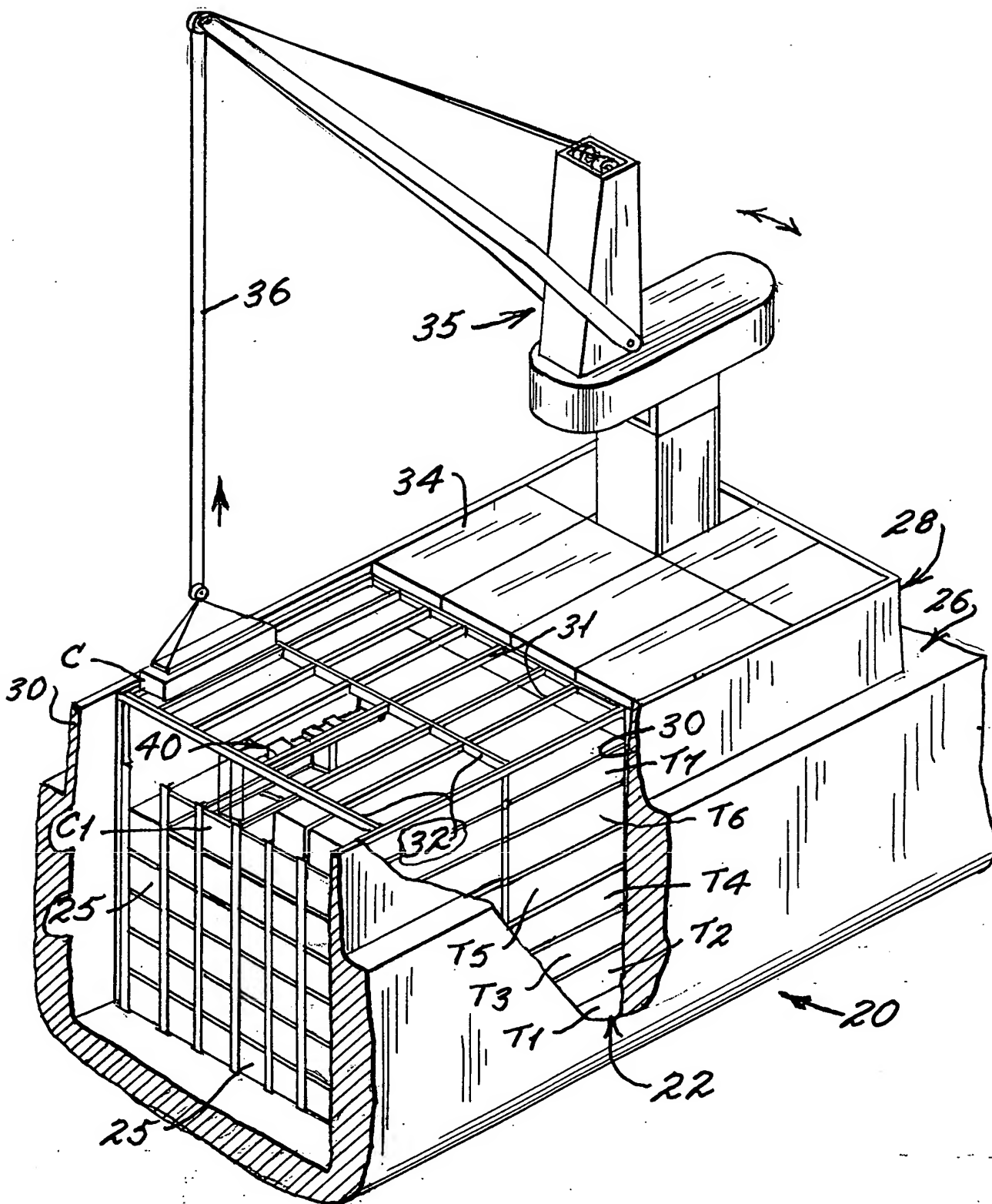


Fig. 1



2/9

Fig. 2

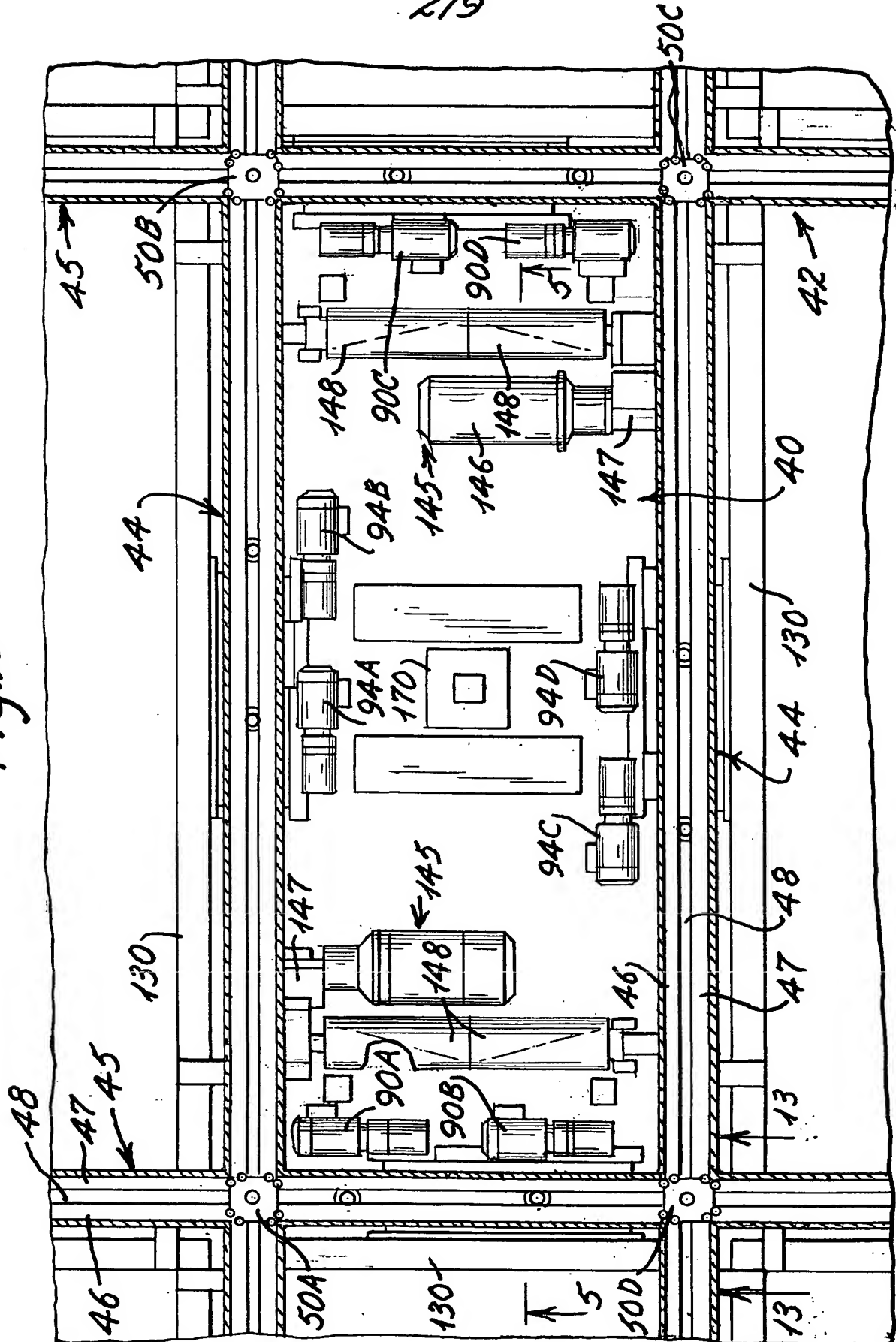
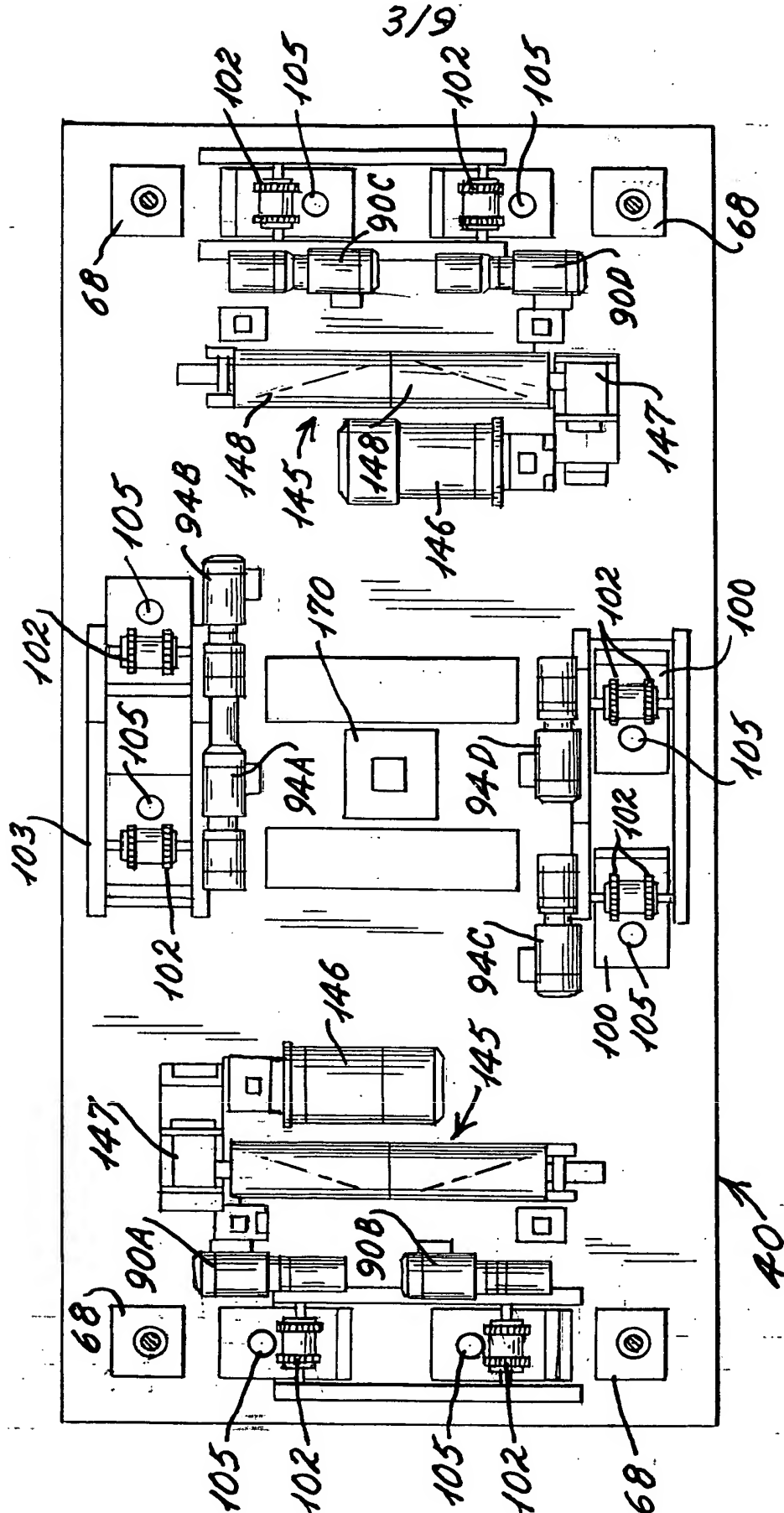
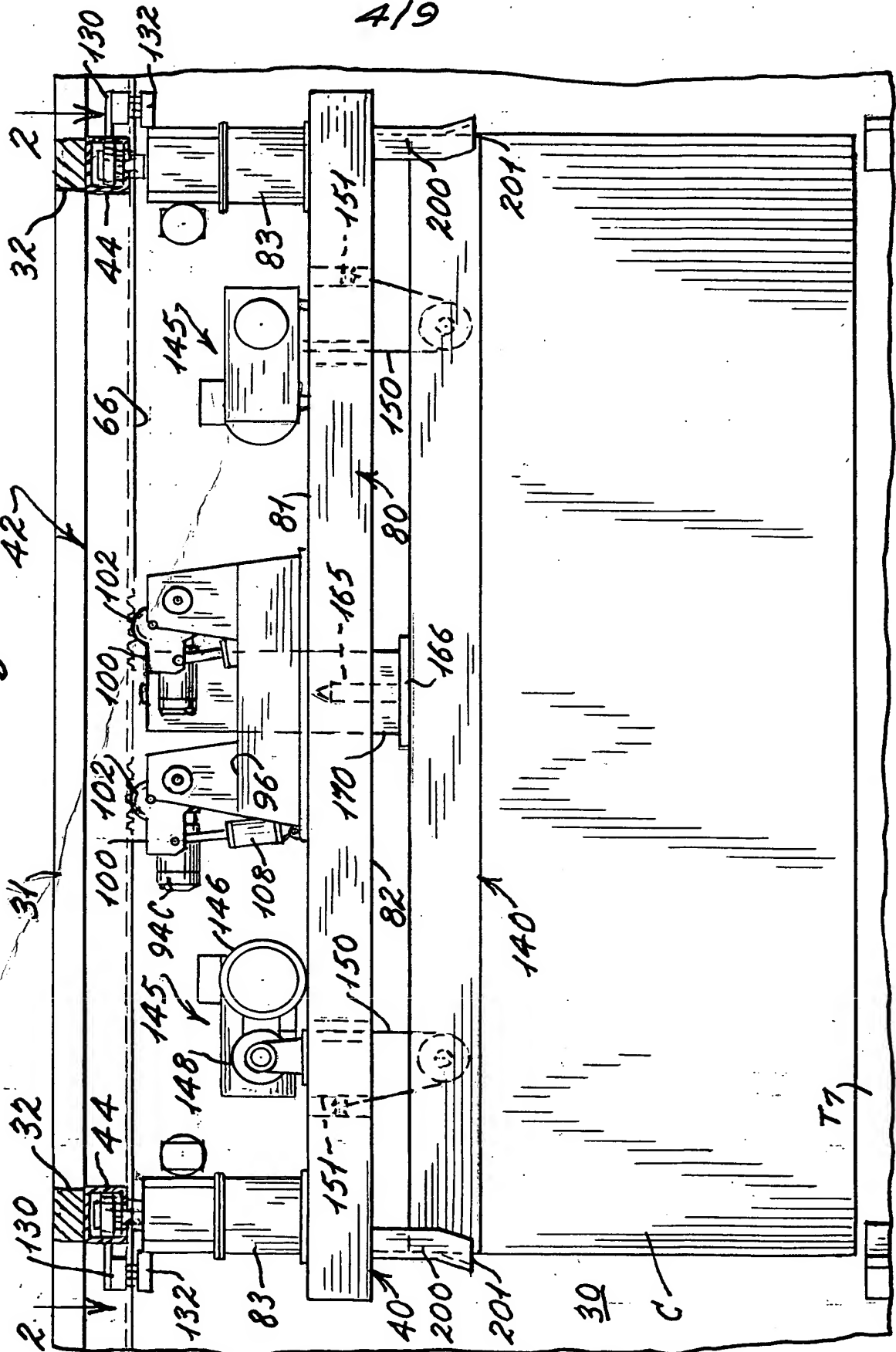


Fig. 3

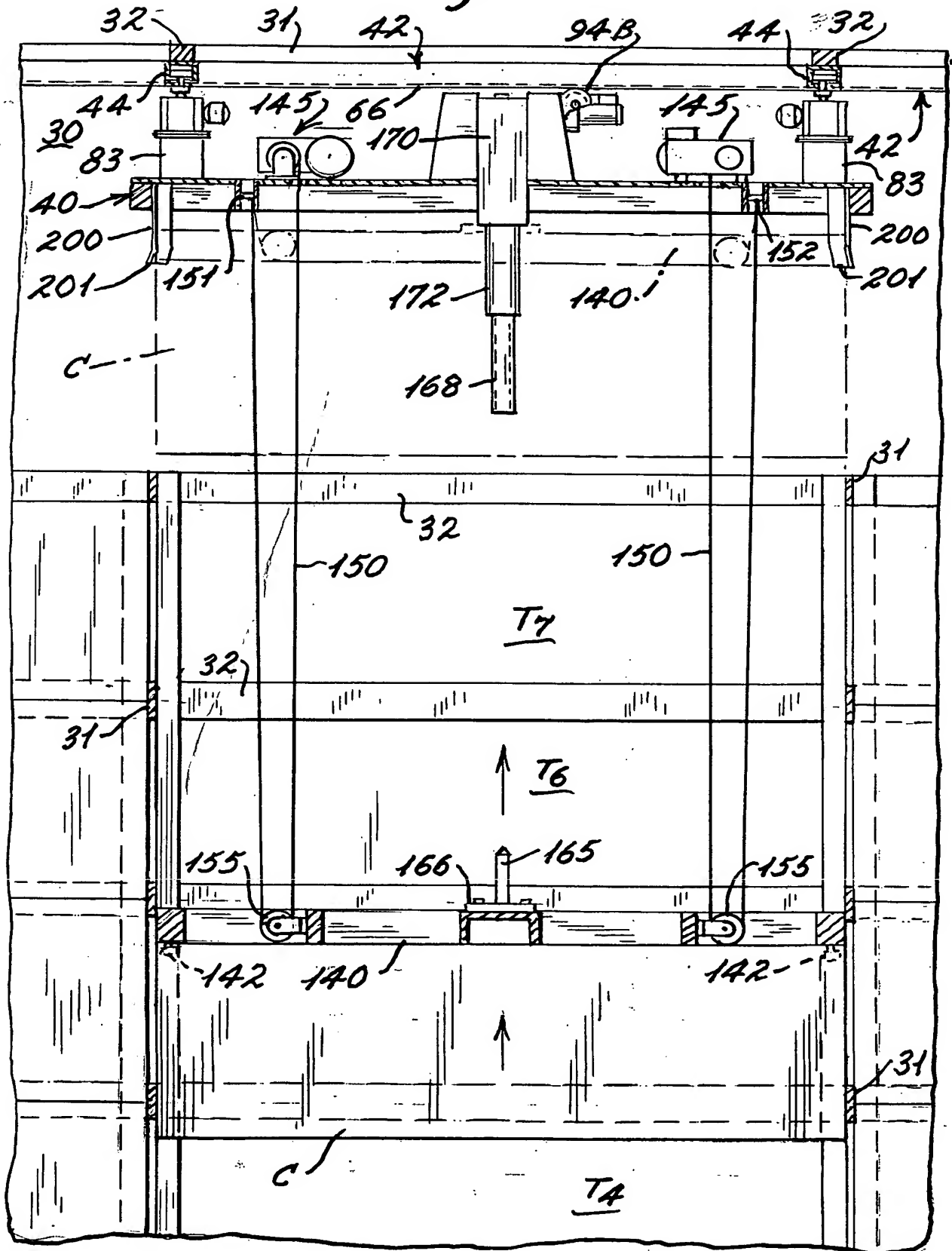


4/9

Fig. 4



519
Fig. 5



619

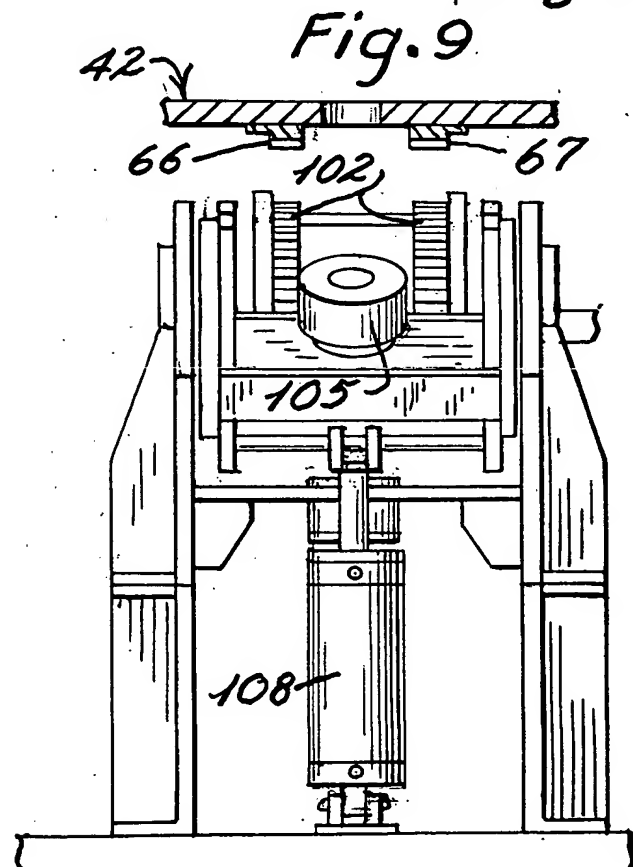
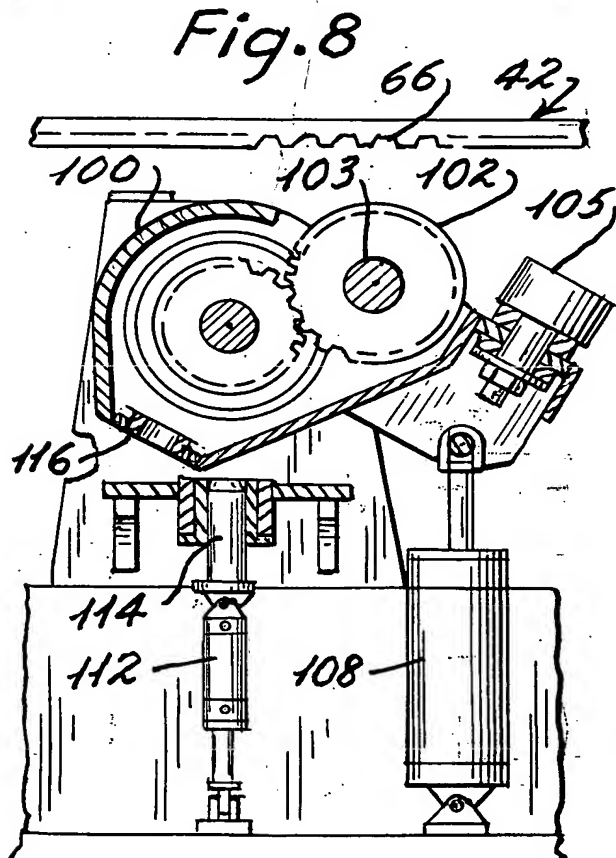
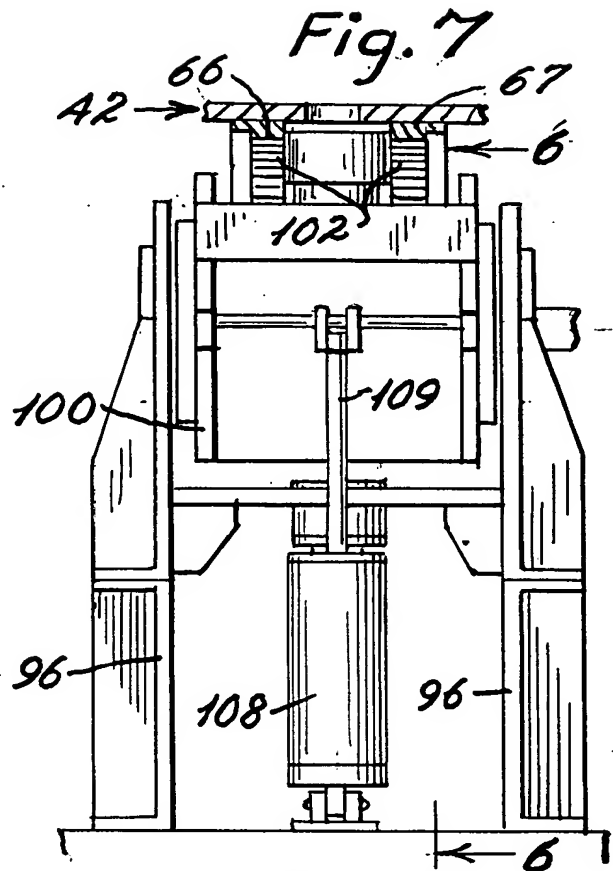
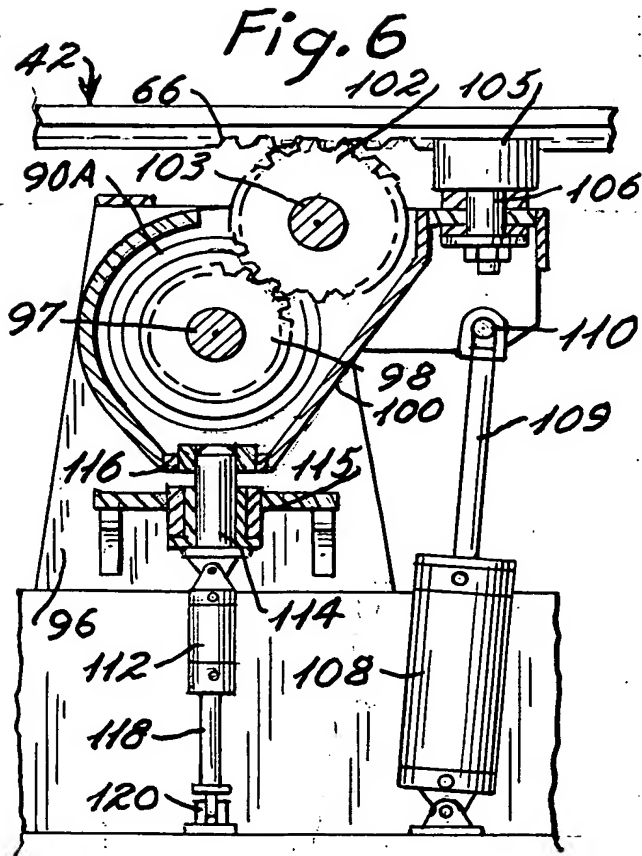


Fig. 10

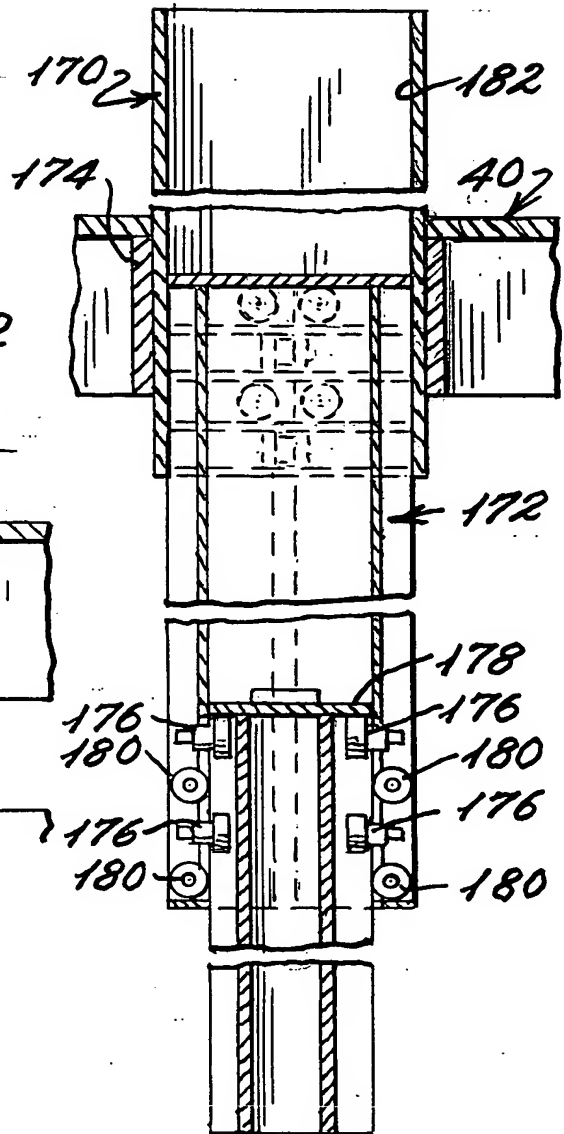
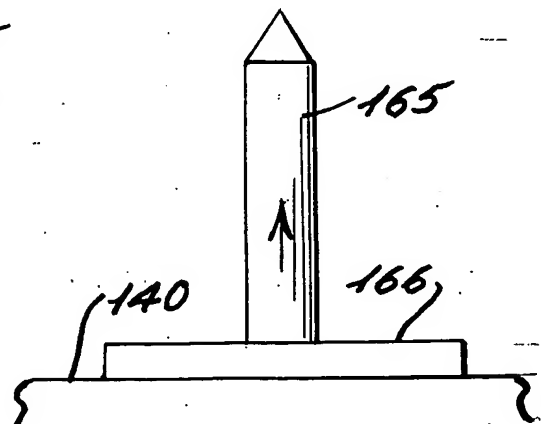


Fig. 1 is a cross-sectional view of a multi-layered electronic device. It shows a central core (168) surrounded by a first layer (175) and a second layer (180). The device is sealed with a third layer (176) and a fourth layer (175). Various components are labeled with numbers 168, 175, 176, and 180.



8/9

Fig. 13

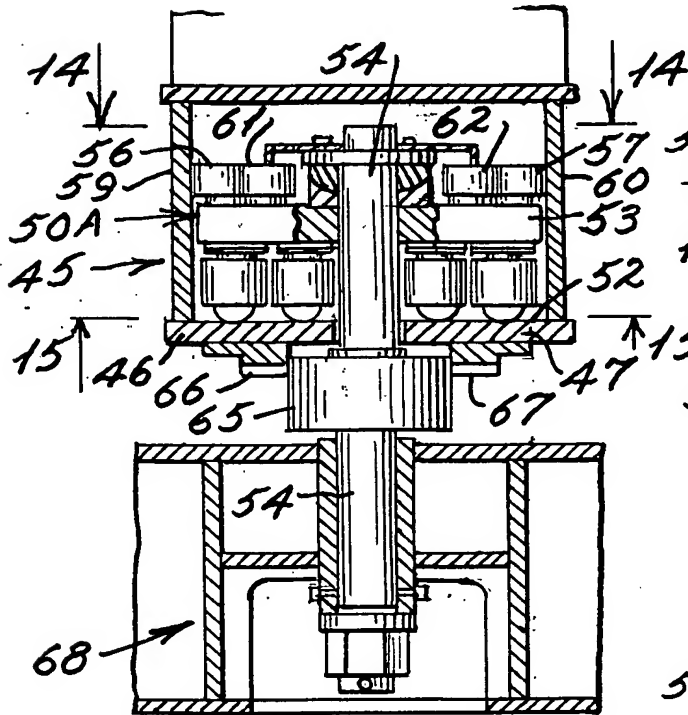


Fig. 14

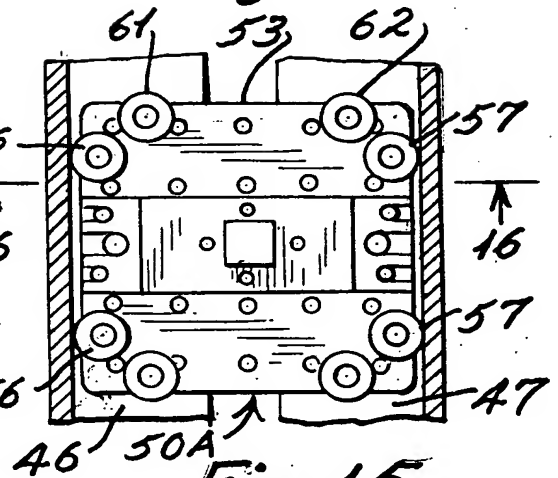


Fig. 15

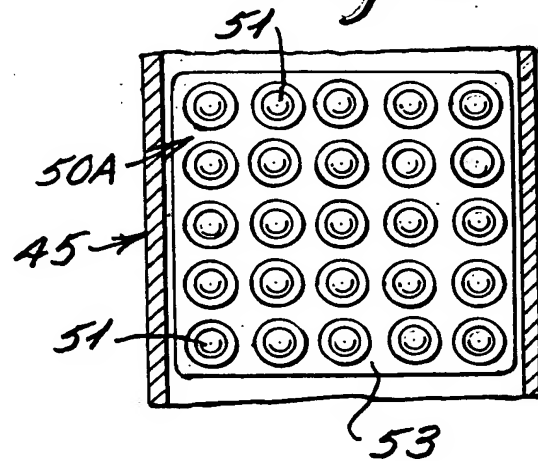
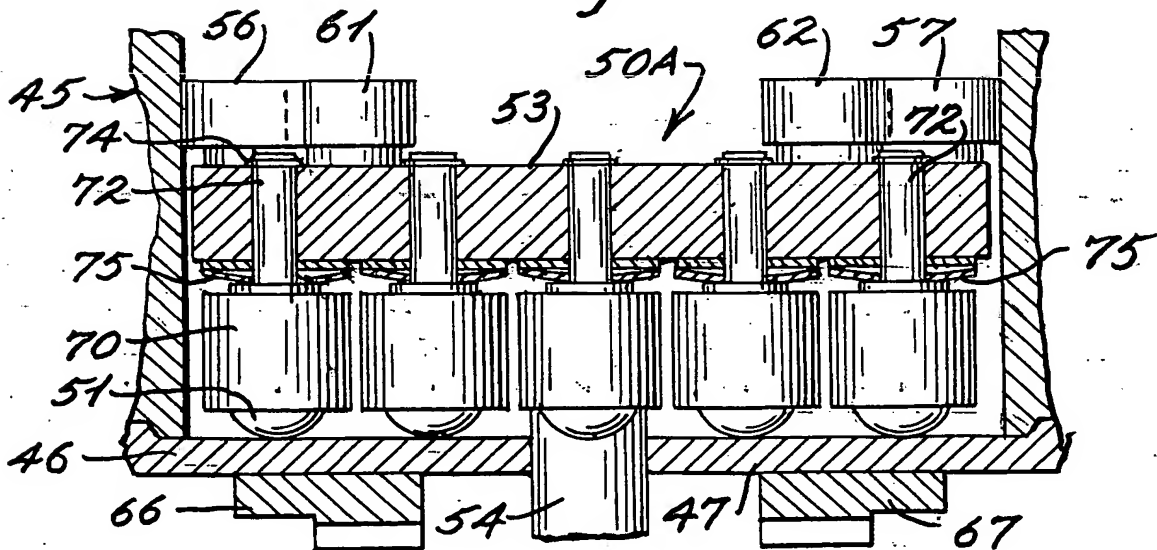


Fig. 16



9/9

Fig.17

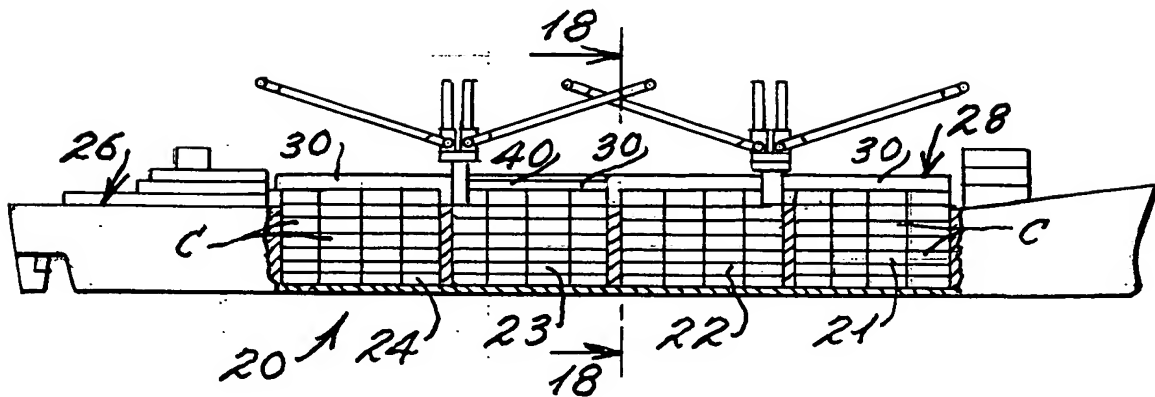


Fig.18

